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(54) Title: SYSTEM FOR AND METHOD OF CLEANING OF COPPER WIRE USING PLASMA, ACTIVATED OR REDUCED GAS ATMOSPHERE

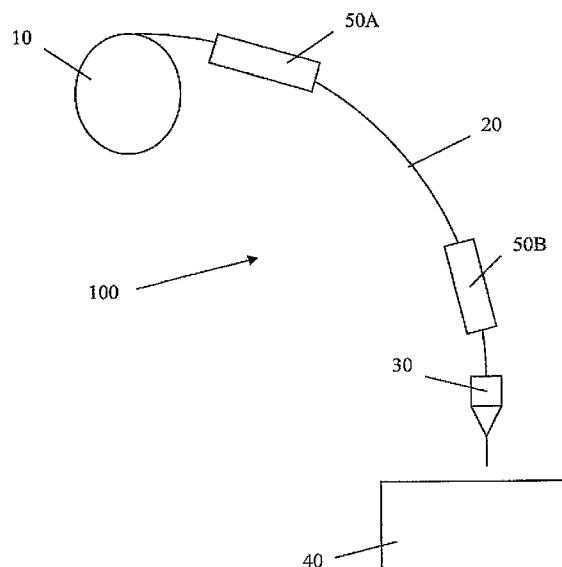


FIG. 1

(57) Abstract: The present invention relates to a method of and an apparatus (100) for cleaning oxides from bonding wire (20) stands using a plasma, activated or reducing gas prior to using the wire (20) in a wire bonding process.





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